IGBT - Field Stop

600 V, 40 A

FGH40N60SMDF

Description

Using Novel Field Stop IGBT Technology, ON Semiconductor's new series of field stop 2nd generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

Features

- Maximum Junction Temperature: $T_J = 175$ °C
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.9 \text{ V (Typ.)} @ I_C = 40 \text{ A}$
- High Input Impedance
- Fast Switching: $E_{OFF} = 6.5 \,\mu J/A$
- Tightened Parameter Distribution
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

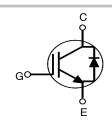
Applications

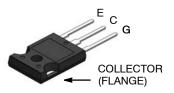
• Solar Inverter, UPS, Welder, PFC, Telecom, ESS



ON Semiconductor®

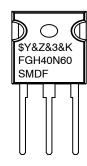
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TO-247-3LD CASE 340CK

MARKING DIAGRAMS



\$Y = ON Semiconductor Logo &Z = Assembly Plant Code &3 = Numeric Date Code &K = Lot Code

FGH40N60SMDF = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

1

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit	
Collector to Emitter Voltage			600	V
Gate to Emitter Voltage		V _{GES}	±20	V
Collector Current	T _C = 25°C	I _C	80	Α
Collector Current	T _C = 100°C		40	Α
Pulsed Collector Current (Note 1)	T _C = 25°C	I _{CM}	120	Α
Maximum Power Dissipation	T _C = 25°C	P _D	349	W
Maximum Power Dissipation	T _C = 100°C	7 [174	W
Operating Junction Temperature	-	TJ	-55 to +175	°C
Storage Temperature Range		T _{stg}	-55 to +175	°C
Maximum Lead Temp. for Soldering Purposes, 1/8" from Cas	se for 5 Seconds	TL	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case (IGBT)	$R_{\theta JC}$	0.43	°C/W
Thermal Resistance, Junction to Case (Diode)	$R_{\theta JC}$	1.45	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FGH40N60SMDF	FGH40N60SMDF	TO-247-3LD	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector to Emitter Breakdown Voltage	BV _{CES}	V _{GE} = 0 V, I _C = 250 μA	600	-	-	V
Temperature Coefficient of Breakdown Voltage	ΔBV _{CES} / ΔΤ _J	$V_{GE} = 0 \text{ V, } I_{C} = 250 \mu\text{A}$	-	0.6	-	V/°C
Collector Cut-Off Current	I _{CES}	V _{CE} = V _{CES} , V _{GE} = 0 V	-	_	250	μΑ
G-E Leakage Current	I _{GES}	V _{GE} = V _{GES} , V _{CE} = 0 V	-	-	±400	nA
ON CHARACTERISTICS						
G-E Threshold Voltage	V _{GE(th)}	I_C = 250 μ A, V_{CE} = V_{GE}	3.5	4.6	6.0	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C = 40 A, V _{GE} = 15 V	-	1.9	2.5	V
		I _C = 40 A, V _{GE} = 15 V, T _C = 150°C	-	2.1	-	V

^{1.} Repetitive rating: Pulse width limited by max. junction temperature

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted) (continued)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ies}	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	-	1880	-	pF
Output Capacitance	C _{oes}		-	180	-	pF
Reverse Transfer Capacitance	C _{res}		-	50	-	pF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(on)}	V _{CC} = 400 V, I _C = 40 A,	-	12	-	ns
Rise Time	t _r	$R_G = 6 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	-	20	-	ns
Turn-Off Delay Time	t _{d(off)}		-	92	-	ns
Fall Time	t _f		-	13	20	ns
Turn-On Switching Loss	E _{on}		-	1.3	-	mJ
Turn-Off Switching Loss	E _{off}		-	0.26	-	mJ
Total Switching Loss	E _{ts}		-	1.56	-	mJ
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, I_{C} = 40 \text{ A},$	-	12	-	ns
Rise Time	t _r	$R_G = 6 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 150^{\circ}C$	-	19	-	ns
Turn-Off Delay Time	t _{d(off)}	7	_	97	-	ns
Fall Time	t _f	7	_	14	21	ns
Turn-On Switching Loss	E _{on}	7	_	2.09	-	mJ
Turn-Off Switching Loss	E _{off}	7	_	0.44	-	mJ
Total Switching Loss	E _{ts}	1	-	2.53	-	mJ
Total Gate Charge	Qg	V _{CE} = 400 V, I _C = 40 A,	-	119	-	nC
Gate to Emitter Charge	Q _{ge}	V _{GE} = 15 V	-	13	-	nC
Gate to Collector Charge	Q _{gc}	1	-	58	-	nC

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_C = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition	ons	Min	Тур	Max	Unit
Diode Forward Voltage	V _{FM}	I _F = 20 A	T _C = 25°C	_	1.3	1.7	V
			T _C = 150°C	_	1.2	_	
Diode Reverse Recovery Time	t _{rr}	I _F = 20 A,	T _C = 25°C	_	70	90	ns
		di _F /dt = 200 A/μs	T _C = 150°C	_	126	_	
Diode Reverse Recovery Charge	Q _{rr}		T _C = 25°C	_	207	290	nC
			T _C = 150°C	_	638	_	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

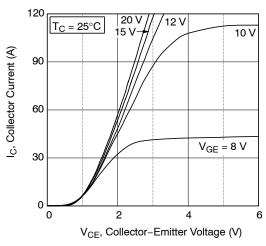


Figure 1. Typical Output Characteristics

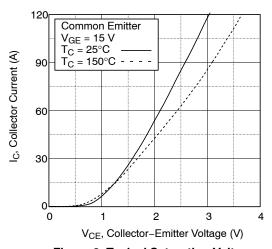


Figure 3. Typical Saturation Voltage Characteristics

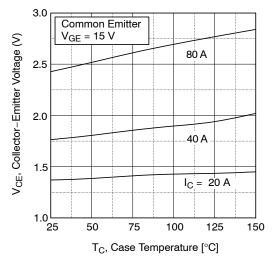


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

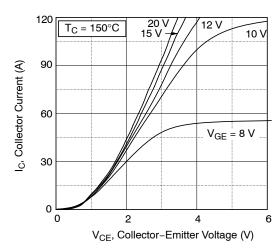


Figure 2. Typical Output Characteristics

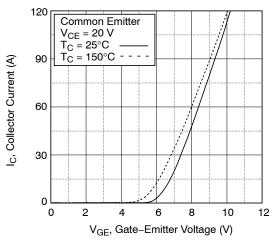


Figure 4. Transfer Characteristics

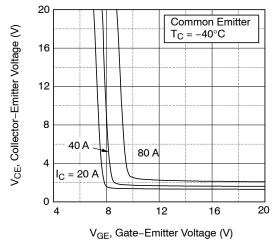


Figure 6. Saturation Voltage vs V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

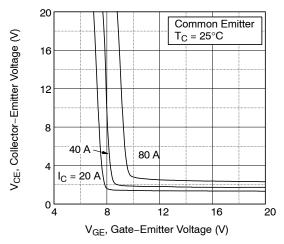


Figure 7. Saturation Voltage vs. V_{GE}

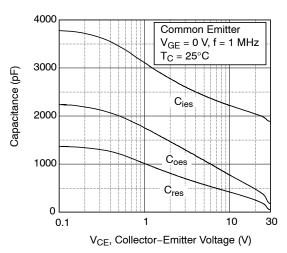


Figure 9. Capacitance Characteristics

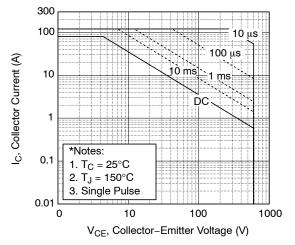


Figure 11. SOA Characteristics

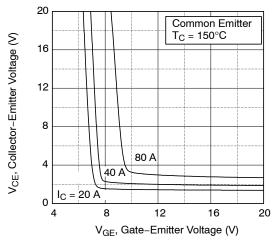


Figure 8. Saturation Voltage vs. V_{GE}

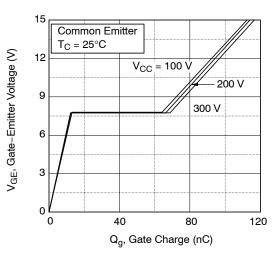


Figure 10. Gate Charge Characteristics

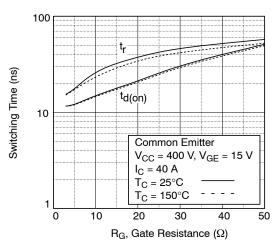


Figure 12. Turn-On Characteristics vs. Gate Resistance

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

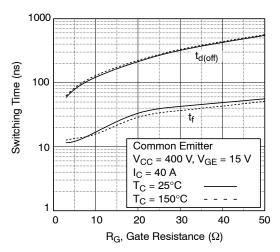


Figure 13. Turn-Off Characteristics vs. Gate Resistance

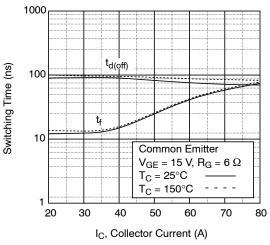


Figure 15. Turn-Off Characteristics vs. Collector Current

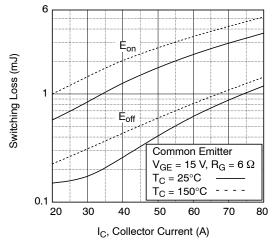


Figure 17. Switching Loss vs. Collector Current

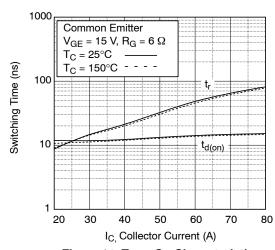


Figure 14. Turn-On Characteristics vs. Collector Current

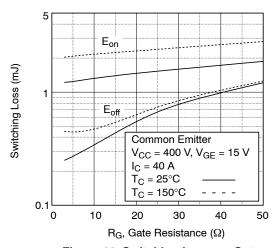


Figure 16. Switching Loss vs. Gate Resistance

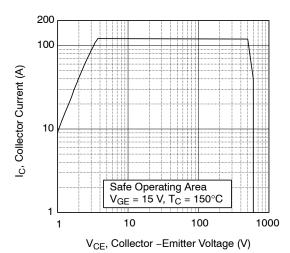


Figure 18. Turn-Off Switching SOA Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

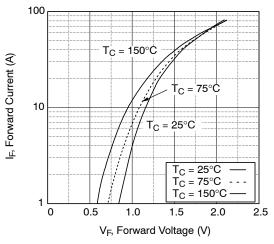


Figure 19. Forward Characteristics

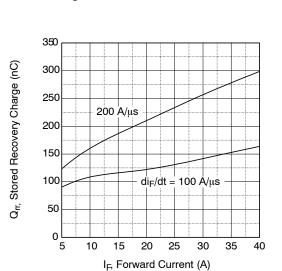


Figure 21. Stored Charge

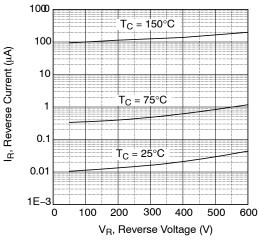


Figure 20. Reverse Current

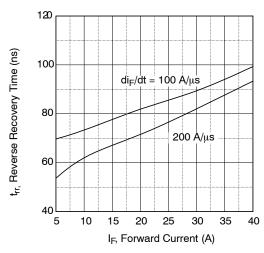


Figure 22. Reverse Recovery Time

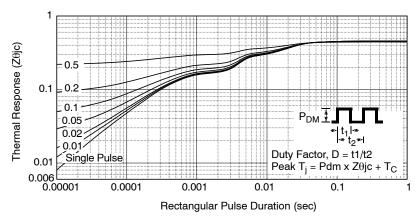
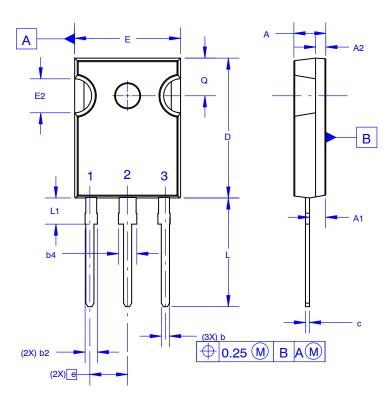


Figure 23. Transient Thermal Impedance of IGBT

TO-247-3LD SHORT LEAD

CASE 340CK ISSUE A





- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

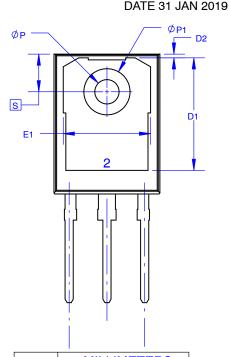
A = Assembly Location

Y = Year

WW = Work Week

ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIM	MIL	LIMET	ERS
DIIVI	MIN	NOM	MAX
Α	4.58	4.70	4.82
A 1	2.20	2.40	2.60
A2	1.40	1.50	1.60
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
b4	2.42	2.54	2.66
С	0.51	0.61	0.71
D	20.32	20.57	20.82
D1	13.08	~	~
D2	0.51	0.93	1.35
E	15.37	15.62	15.87
E1	12.81	?	~
E2	4.96	5.08	5.20
е	~	5.56	~
L	15.75	16.00	16.25
L1	3.69	3.81	3.93
ØΡ	3.51	3.58	3.65
ØP1	6.60	6.80	7.00
Q	5.34	5.46	5.58
S	5.34	5.46	5.58

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 GT50JR22(STA1ES)
 TIG058E8-TL-H
 VS-CPV364M4KPBF
 NGTB25N120FL2WAG
 NGTG40N120FL2WG
 RJH60F3DPQ-A0#T0

 APT40GR120B2SCD10
 APT15GT120BRG
 APT20GT60BRG
 NGTB75N65FL2WAG
 NGTG15N120FL2WG
 IXA30RG1200DHGLB

 IXA40RG1200DHGLB
 APT70GR65B2DU40
 NTE3320
 IHFW40N65R5SXKSA1
 APT70GR120J
 APT35GP120JDQ2

 IKZA40N65RH5XKSA1
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 IGW08T120FKSA1
 IGW75N60H3FKSA1
 HGTG40N60B3
 FGH60N60SMD_F085

 FGH75T65UPD
 STGWA15H120F2
 IKA10N60TXKSA1
 IHW20N120R5XKSA1
 RJH60D2DPP-M0#T2
 IKP20N60TXKSA1

 IHW20N65R5XKSA1
 IDW40E65D2FKSA1